imall

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Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



HDSM-431W/433W

0.39 inch (10.0 mm) Single-Digit Surface Mount LED Display

Data Sheet



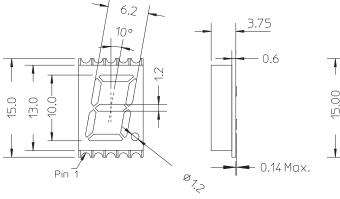
Description

This is 0.39" (10.0 mm) height single-digit display. This device utilizes white ChipLED. This device comes with top surface gray and white segments.

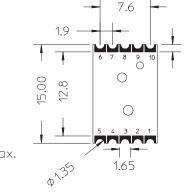
White Description			
HDSM-431W	Common Anode, Right Hand Decimal		
HDSM- 433W	Common Cathode, Right Hand Decimal		

Features

- 0.39" digit height
- Low current operation
- Excellent characters appearance
- Available in CA and CC
- 1000 pieces per reel
- Moisture Sensitivity Level: Level 3
- RoHS compliant









Note:

1. All dimensions are in millimeters.

2. Tolerance is ±0.25 mm (0.01"), unless otherwise specified.

CAUTION: LEDs are Class 1A ESD sensitive per JESD22-A114C.01. Please observe appropriate precautions during handling and processing.

Package Dimensions

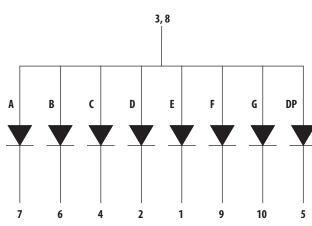
Pin Connection (Common Anode)

Pin No.	Connection
1	CATHODE E
2	CATHODE D
3	COMMON ANODE
4	CATHODE C
5	CATHODE DP
6	CATHODE B
7	CATHODE A
8	COMMON ANODE
9	CATHODE F
10	CATHODE G

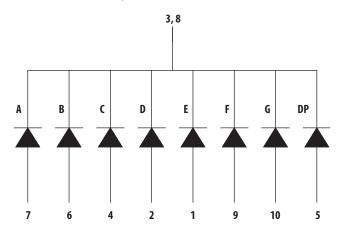
Pin Connection (Common Cathode)

Pin No.	Connection
1	ANODE E
2	ANODE D
3	COMMON CATHODE
4	ANODE C
5	ANODE DP
6	ANODE B
7	ANODE A
8	COMMON CATHODE
9	ANODE F
10	ANODE G

Internal Circuit Diagram (Common Anode)



Internal Circuit Diagram (Common Cathode)



Absolute Maximum Ratings @ T_A = 25 $^\circ C$

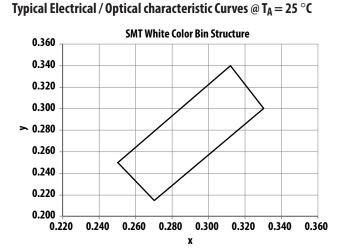
Parameter	White	Unit	
Power Dissipation Per Segment	39	mW	
Peak Forward Current Per Segment (1/10 Duty Cycle., 0.1 ms pulse width)	80	mA	
Continuous Forward Current Per Segment Derating Linearly From 25 °C Per Segment	10	mA	
	0.083	Z	
Reverse Voltage Per Segment	Not designed for reverse bias	V	
Operating Temperature Range	-40 °C to +85 °C	°C	
Storage Temperature Range	-40 °C to +85 °C	°C	

Electrical / Optical Characteristics @ T_A = 25 $^\circ C$

White

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition
Average Luminous Intensity	Iv	24	40	_	mcd	$I_F = 5 \text{ mA}$
Chromaticity Coordinates	(x,y)		See Figu	re 1		$I_F = 5 \text{ mA}$
Forward Voltage, Per Segment	V _F	-	2.95	3.8	V	I _F = 5 mA
Reverse Current, Per Segment ^[1]	I _R	-	-	100	μΑ	$V_R = 5 V$
Luminous Intensity Matching Ratio	I _{V-m}	_	_	2:1	_	$I_F = 5 \text{ mA}$

Note 1. Indicates production final test condition only. Long term reverse biasing is not recommended.



Chromaticity Coordinates						
x	0.250	0.270	0.330	0.312		
у	0.250	0.215	0.300	0.340		

Figure 1. Color bin limit (CIE 1931 Chromatically Diagram) [Tolerance: ±0.02]

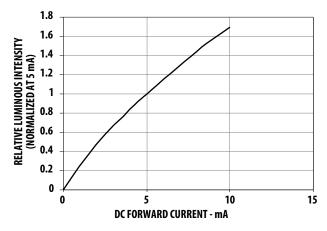


Figure 2. Relative luminous intensity versus forward current

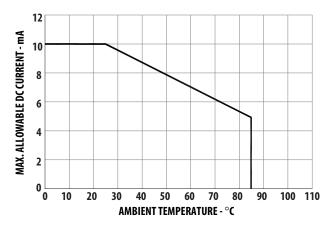


Figure 4. Allowable DC Current Versus Ambient Temperature

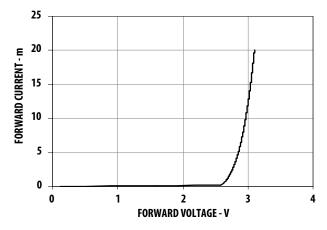
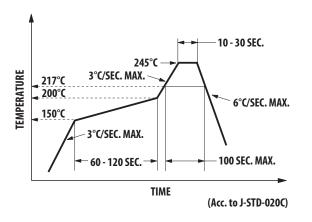


Figure 3. Forward current versus forward voltage

SMT Soldering Profile

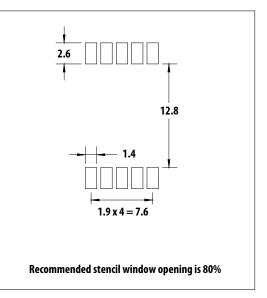
Pb free reflow soldering Profile

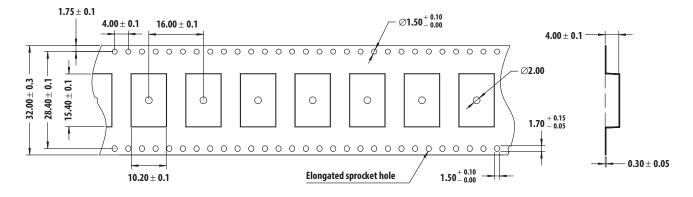


Notes:

- 1. The peak temperature refers to the peak package body temperature.
- Number of reflow process shall be limited to maximum 2 times only. Cooling process to normal temperature is required between first and second soldering process.

Recommended Soldering Pattern (unit: mm)





Tape Specification (unit: mm)

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